## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## **CHIP PACKAGE STRUCTURE**

the specification of whic				
X is attached hereto.				
was filed on				
as Application Seri	ai No	and was amended on_		·•
specification, including t	he claims, as amende	and understand the content of by any amendment referre rmation which is material to	ed to above.	
		of Federal Regulations, § 1		lability of th
		der Title 35, United States (		of any foreic
		ate listed below and have		_
		ificate having a filing date be		
on which priority is claim				• •
Prior Foreign Application	ា(s):			
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
92212987	Taiwan, R.O.C.	2003/7/16	Х	
ransact all business in t	he Patent and Tradem	and/or agent(s) to prosect the prosect the connected the rev	with:	
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## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any pat nts issued thereon.

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